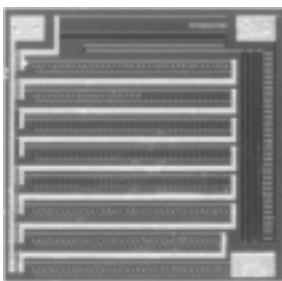


Thin Film Voltage Divider Resistors



Product may not
be to scale

FEATURES

- Variable ratios
- Chip size: 0.058 inch square
- Resistor material: tantalum nitride, self-passivating
- Oxidized silicon substrate for good power dissipation
- Moisture resistant

The ATA voltage divider is a versatile two-resistor tapped chip whose R_A/R_B ratio can be specified within the values of 1:1 to 20:1. These chips are manufactured using Vishay Electro-Films (EFI) sophisticated Thin Film equipment and manufacturing technology. The ATAs are 100% electrically tested and visually inspected to MIL-STD-883.

APPLICATIONS

Vishay EFI ATA voltage divider resistor-ratio chips are designed for the tight ratio tolerances generally required in amplifier feedback circuits. The great range of ratio choices makes them specially suitable for this application.

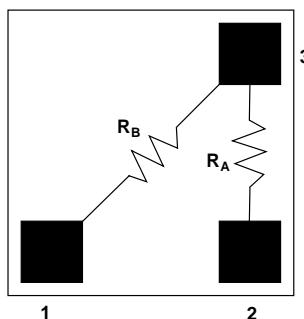
TEMPERATURE COEFFICIENT OF RESISTANCE VALUES AND TOLERANCES	
Resistance ($R_A + R_B$)	25kΩ
Tolerances ($R_A + R_B$)	± 5%
Greatest ratio (R_A/R_B)	20:1
TCR	± 50ppm/°C

VOLTAge
CHIP
DIVIDERS

STANDARD ELECTRICAL SPECIFICATIONS	
PARAMETER	
TCR tracking between R_A and R_B	± 5ppm/°C
Noise, MIL-STD-202, Method 308	- 35dB typical
Moisture resistance, MIL-STD-202, Method 106	± 0.5% maximum ΔR/R
Stability, 1000 hours, + 125°C, 25mW	± 0.25% maximum ΔR/R
Operating temperature range	- 55°C to + 125°C
Thermal shock, MIL-STD-202 Method 107, Test condition F	± 0.1% maximum ΔR/R
High temperature exposure + 150°C, 100 hours	± 0.2% maximum ΔR/R
Dielectric voltage breakdown	200V
Insulation resistance	10 ¹² minimum
Operating voltage	100V maximum
DC power rating at + 70°C (derated to zero at 175°C)	50mW per resistor
5 x rated power short-time overload, + 25°C, 5 seconds	± 0.1% maximum ΔR/R

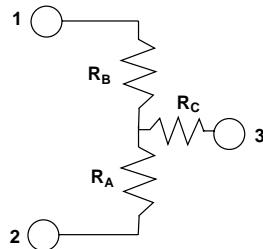
VISHAY ELECTRO-FILMS • FRANCE +33.4.93.37.28.24 FAX: +33.4.93.37.27.31 • GERMANY +49.9287.710 FAX: +49.9287.70435 • ISRAEL +972.3.557.0945 FAX: +972.3.558.9121
• ITALY +39.2.300.11911 FAX: +39.2.300.11999 • JAPAN +81.42.729.0661 FAX: +81.42.729.3400 • SINGAPORE +65.788.6668 FAX: +65.788.0988
• SWEDEN +46.8.594.70590 FAX: +46.8.594.70581 • UK +44 191 514 8237 FAX: +44 1953 457 722 • USA: (401) 738-9150 FAX: (401) 738-4389

CONFIGURATIONS



Shaded areas represent bonding pads.

$$\text{ATTENUATOR FACTOR} = \frac{R_A}{R_A + R_B}$$



Any ratio R_A/R_B from 1 to 20 is available to $\pm 0.05\%$

R_c is a parasitic resistor approximately 5Ω in value, which does not effect the performance of the device when it is used into a high impedance load.

MECHANICAL SPECIFICATIONS in inches

PARAMETER																				
Chip size	$0.058 \times 0.058 \pm 0.003$ (1.47 x 1.47 \pm 0.076mm)																			
Chip thickness	0.010 ± 0.002 (0.254 \pm 0.05mm)																			
Chip substrate material	Oxidized silicon, 10kÅ minimum SiO ₂																			
Resistor material	Tantalum nitride, self-passivating																			
Bonding pads	0.005×0.005 (0.127 x 0.127mm)																			
Number of top pads	3																			
Pad material	10kÅ minimum aluminum																			
Backing	None, lapped semiconductor silicon																			

OPTION: Gold back for eutectic die attach
Contact Applications Engineer

ATTENUATION TABLE

PART # ATA	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	RATIO ACCURACY	TEMPERATURE TRACKING
RATIO R_A/R_B	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	$\pm 0.05\%$	$\pm 5\text{ppm}/^\circ\text{C}$ maximum $\pm 2\text{ppm}/^\circ\text{C}$ typical
ATTENUATOR FACTOR	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	$\pm 0.025\%$ to $\pm 0.048\%$	$\pm 2.5\text{ppm}/^\circ\text{C}$ to $\pm 4.8\text{ppm}/^\circ\text{C}$ maximum $\pm 1\text{ppm}/^\circ\text{C}$ to $\pm 2\text{ppm}/^\circ\text{C}$ typical
$R_B/R_A + R_B$	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	21		
ATTENUATOR FACTOR	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	$\pm 0.025\%$ to $\pm 0.0025\%$	$\pm 2.5\text{ppm}/^\circ\text{C}$ to $\pm 0.25\text{ppm}/^\circ\text{C}$ maximum $\pm 1\text{ppm}/^\circ\text{C}$ to $\pm 0.15\text{ppm}/^\circ\text{C}$ typical
$R_A/R_A + R_B$	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	21		

*Depends on ratio

ORDERING INFORMATION

Example: 100% visualized, 25kΩ, $\pm 5\%$, $\pm 100\text{ppm}/^\circ\text{C}$ TCR, Ratio = 19.0, Aluminum Pads, Class H

P/N:	W	ATA	003	1900	B	J
INSPECTION /PACKAGING	PRODUCT FAMILY	PROCESS CODE	RATIO VALUE	MULTIPLIER CODE	TOLERANCE CODE	
W = 100% visually inspected parts per MIL-STD-883	003 = Class H	005 = Class K	Use first 4 significant digits of the ratio RA/RB	C = 0.001	J = 5.0%	
X = Sample, visually inspected loaded in matrix trays (4% AQL)			- Any ratio between 1 to 20	B = 0.01		

VISHAY ELECTRO-FILMS • FRANCE +33.4.93.37.28.24 FAX: +33.4.93.37.27.31 • GERMANY +49.9287.710 FAX: +49.9287.70435 • ISRAEL +972.3.557.0945 FAX: +972.3.558.9121

• ITALY +39.2.300.11911 FAX: +39.2.300.11999 • JAPAN +81.42.729.0661 FAX: +81.42.729.3400 • SINGAPORE +65.788.6668 FAX: +65.788.0988

• SWEDEN +46.8.594.70590 FAX: +46.8.594.70581 • UK +44.191.514.8237 FAX: +44.1953.457.722 • USA: (401) 738-9150 FAX: (401) 738-4389